PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT4569312

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JU-GWANG LEE	06/03/2017
BYUNG-HOON KIM	06/08/2017
HA-EUN OH	06/13/2017
JONG-HYUN LEE	07/20/2017
JI-HO WOO	07/20/2017

RECEIVING PARTY DATA

Name:	MULTINEX CO., LTD.	
Street Address:	1F, 14, TEHERAN-RO 103-GIL, GANGNAM-GU	
City:	SEOUL	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	06173	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	29615304

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: jlee@nutter.com **Correspondent Name:** JOHN J. PENNY, JR.

Address Line 1: 155 SEAPORT BOULEVARD

Address Line 2: NUTTER MCCLENNEN & FISH LLP
Address Line 4: BOSTON, MASSACHUSETTS 02210

ATTORNEY DOCKET NUMBER:	118158-00002
NAME OF SUBMITTER:	JOHN J. PENNY, JR.
SIGNATURE:	/John J. Penny, Jr./
DATE SIGNED:	08/28/2017

Total Attachments: 3

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PATENT REEL: 043424 FRAME: 0679

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PATENT REEL: 043424 FRAME: 0680

Attorney Docket No.: <u>118158-00002</u>

COMBINED DECLARATION AND ASSIGNMENT

Title of Invention: LAYERED HAT This declaration and assignment is directed to the application shown below (the "Application"): The attached or filed herewith application of (list of named inventors) or The United States application or PCT international application number
The attached or filed herewith application of (list of named inventors) or The United States application or PCT international application number filed on Declaration As the below named inventor, I hereby declare that: The above-identified application ("Application") was made or authorized by me. I believe that I am the original inventor or an original inventor of a claimed invention or discovery in the Application. I have reviewed and understood the contents of the Application, including the claims, and I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, the United States Code of Federal Regulations, §1.56 for fillings of this Application in the United States of America. I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both for fillings of this Application in the United States of America. Assignment MULTINEX Co., Ltd. IF, 14, Teheran-ro 103-gil, Gangnam-gu, Seoul, KOREA 06173 a corporation organized under and pursuant to the laws of Korea (hereinafter designated as the "Assignee"), I hereby acknowledge that I have assigned the above-identified invention by previous assignment (attached hereto) to Assignee
The United States application or PCT international application number
The United States application or PCT international application number
Declaration As the below named inventor, I hereby declare that: The above-identified application ("Application") was made or authorized by me. I believe that I am the original inventor or an original inventor of a claimed invention or discovery in the Application. I have reviewed and understood the contents of the Application, including the claims, and I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, the United States Code of Federal Regulations, \$1.56 for filings of this Application in the United States of America. I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. \$ 1001 by fine or imprisonment of not more than five (5) years, or both for filings of this Application in the United States of America. Assignment MULTINEX Co., Ltd. 1F, 14, Teheran-ro 103-gil, Gangnam-gu, Seoul, KOREA 06173 a corporation organized under and pursuant to the laws of Korea (hereinafter designated as the "Assignee"), I hereby acknowledge that I have assigned the above-identified invention by previous assignment (attached hereto) to Assignee
As the below named inventor, I hereby declare that: The above-identified application ("Application") was made or authorized by me. I believe that I am the original inventor or an original inventor of a claimed invention or discovery in the Application. I have reviewed and understood the contents of the Application, including the claims, and I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, the United States Code of Federal Regulations, §1.56 for filings of this Application in the United States of America. I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both for filings of this Application in the United States of America. Assignment MULTINEX Co., Ltd. 1F, 14, Teheran-ro 103-gil, Gangnam-gu, Seoul, KOREA 06173 a corporation organized under and pursuant to the laws of Korea (hereinafter designated as the "Assignee"), I hereby acknowledge that I have assigned the above-identified invention by previous assignment (attached hereto) to Assignee
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or
For good and valuable consideration, the sufficiency of which is acknowledged, I hereby assign and transfer and/or have assigned and transferred to Assignee:
my entire right, title, and interest in, to, and under the Application, including all priority rights for other countries arising therefrom and the right to claim priority to the Application, all inventions or discoveries therein disclosed, and any and all Letters Patent of the United States, European Patent Office and of all other countries, which may be granted for such inventions or discoveries, or any of them, all such inventions or discoveries and all rights in such Application including any and all provisionals, substitutions, divisions, and continuations thereof, and to all Letters Patent that may be granted for said inventions and discoveries, and in and to all extensions, supplementary protection certificates, reexaminations, renewals, and reissues thereof, to be held and enjoyed by Assignee for its own use and enjoyment to the full end of the term or terms for which such Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me had this assignment and sale not been made.

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PATENT

REEL: 043424 FRAME: 0681

Attorney Docket No.: 118158-00002

I shall execute all papers necessary in connection with the Application in the United States Patent and Trademark Office, European Patent Office, any other patent offices, and under the Patent Cooperation Treaty, and any continuing, divisional, or reissue applications thereof, any reexamination of any of such applications, and any patent term extensions or supplementary protection certificates of any such applications and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

I shall execute all papers necessary in connection with any litigation or any other judicial proceeding in the United States or other country, or any administrative proceeding in the United States Patent and Trademark Office, European Patent Office, any other patent office, or under the Patent Cooperation Treaty concerning the Application(s) or any continuation, divisional, or reissue applications thereof, or any reexamination of any such applications, or any Letters Patent issued therefrom or any patent term extensions or supplementary protection certificates of any such applications and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such litigation or proceeding.

I shall execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

I shall do all other acts which, in the opinion of Assignee, may be necessary or desirable to secure the grant of Letters Patent to Assignee or its nominees, in the United States, by the European Patent Office and in all other countries where Assignee may desire to have such inventions or discoveries, or any of them, patented, with specifications and claims in such form as shall be approved by Assignee and to vest and confirm in Assignee or its nominees the full and complete legal and equitable title to all such Letters Patent.

I hereby (i) authorize and request the Commissioner of Patents to issue any and all Letters Patent of the United States resulting from the Application or any divisional, continuation, or reissue applications thereof, and any reexamination of any of such applications, to Assignee, and (ii) covenant that I have full right to convey the interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

I hereby grant the attorney of record the power to insert on this assignment any further identification which may be necessary or desirable in order to obtain legal recordation of this document.

EGAL NAME OF FIRST INVENTOR: Jn-Gwang LEE	1/4/2/9
Signature	Date
EGAL NAME OF SECOND INVENTOR: Byung-Hoon KIM	6/8/2019
EGAL NAME OF THIRD INVENTOR: Ha-Eum OH	6/13/2017 Date
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	Attorney Docket No.: 118158-00002
LEGAL NAME OF FOURTH INVENTOR: Jong-Hyun LEE	120/2019
Signature Date	
LEGAL NAME OF FIFTH INVENTOR: JI-16-WOO	
Signature Date	20/2011
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RECORDED: 08/28/2017